Amendments to the Specification:

Please make the following amendments to the specification (material to be inserted in replacement paragraphs or sections is in <u>underline</u>, and material to be deleted is in <u>strikeout</u>).

Please replace the paragraph beginning at page 1, line 4, with the following replacement paragraph:

This application is a divisional application of U.S. non-provisional patent application Serial No. 09/778,232, <u>now U.S. Patent no. 6,685,794</u>, entitled "Method and Apparatus for Bonding Optical Disc Substrates Together, and Method For Supplying Liquid Material," filed on February 6, 2001, hereby incorporated by reference.